



L3GD20

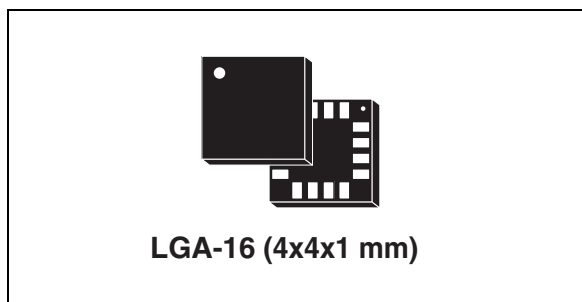
MEMS motion sensor: three-axis digital output gyroscope

Features

- Three selectable full scales (250/500/2000 dps)
- I²C/SPI digital output interface
- 16 bit-rate value data output
- 8-bit temperature data output
- Two digital output lines (interrupt and data ready)
- Integrated low- and high-pass filters with user-selectable bandwidth
- Wide supply voltage: 2.4 V to 3.6 V
- Low voltage-compatible IOs (1.8 V)
- Embedded power-down and sleep mode
- Embedded temperature sensor
- Embedded FIFO
- High shock survivability
- Extended operating temperature range (-40 °C to +85 °C)
- ECOPACK[®] RoHS and “Green” compliant

Applications

- Gaming and virtual reality input devices
- Motion control with MMI (man-machine interface)
- GPS navigation systems
- Appliances and robotics



Description

The L3GD20 is a low-power three-axis angular rate sensor.

It includes a sensing element and an IC interface capable of providing the measured angular rate to the external world through a digital interface (I²C/SPI).

The sensing element is manufactured using a dedicated micro-machining process developed by STMicroelectronics to produce inertial sensors and actuators on silicon wafers.

The IC interface is manufactured using a CMOS process that allows a high level of integration to design a dedicated circuit which is trimmed to better match the sensing element characteristics.

The L3GD20 has a full scale of $\pm 250/\pm 500/\pm 2000$ dps and is capable of measuring rates with a user-selectable bandwidth.

The L3GD20 is available in a plastic land grid array (LGA) package and can operate within a temperature range of -40 °C to +85 °C.

Table 1. Device summary

Order code	Temperature range (°C)	Package	Packing
L3GD20	-40 to +85	LGA-16 (4x4x1 mm)	Tray
L3GD20TR	-40 to +85	LGA-16 (4x4x1 mm)	Tape and reel

Contents

1	Block diagram and pin description	7
1.1	Pin description	7
2	Mechanical and electrical specifications	9
2.1	Mechanical characteristics	9
2.2	Electrical characteristics	10
2.3	Temperature sensor characteristics	10
2.4	Communication interface characteristics	11
2.4.1	SPI - serial peripheral interface	11
2.4.2	I2C - Inter IC control interface	12
2.5	Absolute maximum ratings	13
2.6	Terminology	14
2.6.1	Sensitivity	14
2.6.2	Zero-rate level	14
2.7	Soldering information	14
3	Application hints	15
4	Digital main blocks	16
4.1	Block diagram	16
4.2	FIFO	16
4.2.1	Bypass mode	17
4.2.2	FIFO mode	17
4.2.3	Stream mode	18
4.2.4	Bypass-to-stream mode	20
4.2.5	Stream-to-FIFO mode	20
4.2.6	Retrieve data from FIFO	21
5	Digital interfaces	22
5.1	I2C serial interface	22
5.1.1	I2C operation	23
5.2	SPI bus interface	24
5.2.1	SPI read	26

5.2.2	SPI write	27
5.2.3	SPI read in 3-wire mode	27
6	Output register mapping	29
7	Register description	31
7.1	WHO_AM_I (0Fh)	31
7.2	CTRL_REG1 (20h)	31
7.3	CTRL_REG2 (21h)	32
7.4	CTRL_REG3 (22h)	33
7.5	CTRL_REG4 (23h)	34
7.6	CTRL_REG5 (24h)	34
7.7	REFERENCE/DATACAPTURE (25h)	35
7.8	OUT_TEMP (26h)	35
7.9	STATUS_REG (27h)	36
7.10	OUT_X_L (28h), OUT_X_H (29h)	36
7.11	OUT_Y_L (2Ah), OUT_Y_H (2Bh)	36
7.12	OUT_Z_L (2Ch), OUT_Z_H (2Dh)	36
7.13	FIFO_CTRL_REG (2Eh)	36
7.14	FIFO_SRC_REG (2Fh)	37
7.15	INT1_CFG (30h)	37
7.16	INT1_SRC (31h)	38
7.17	INT1_THS_XH (32h)	39
7.18	INT1_THS_XL (33h)	39
7.19	INT1_THS_YH (34h)	39
7.20	INT1_THS_YL (35h)	39
7.21	INT1_THS_ZH (36h)	40
7.22	INT1_THS_ZL (37h)	40
7.23	INT1_DURATION (38h)	40
8	Package information	42
9	Revision history	43

List of tables

Table 2.	Pin description	8
Table 3.	Mechanical characteristics	9
Table 4.	Electrical characteristics	10
Table 5.	Electrical characteristics	10
Table 6.	SPI slave timing values.	11
Table 7.	I2C slave timing values (TBC)	12
Table 8.	Absolute maximum ratings	13
Table 9.	Serial interface pin description	22
Table 10.	I2C terminology.	22
Table 11.	SAD+read/write patterns.	23
Table 12.	Transfer when master is writing one byte to slave	23
Table 13.	Transfer when master is writing multiple bytes to slave	24
Table 14.	Transfer when master is receiving (reading) one byte of data from slave	24
Table 15.	Transfer when master is receiving (reading) multiple bytes of data from slave	24
Table 16.	Register address map.	29
Table 17.	WHO_AM_I register	31
Table 18.	CTRL_REG1 register	31
Table 19.	CTRL_REG1 description	31
Table 20.	DR and BW configuration setting	31
Table 21.	Power mode selection configuration.	32
Table 22.	CTRL_REG2 register	32
Table 23.	CTRL_REG2 description	32
Table 24.	High-pass filter mode configuration	33
Table 25.	High-pass filter cut off frequency configuration [Hz]	33
Table 26.	CTRL_REG1 register	33
Table 27.	CTRL_REG3 description	33
Table 28.	CTRL_REG4 register	34
Table 29.	CTRL_REG4 description	34
Table 30.	CTRL_REG5 register	34
Table 31.	CTRL_REG5 description	34
Table 32.	REFERENCE register.	35
Table 33.	REFERENCE register description	35
Table 34.	OUT_TEMP register	35
Table 35.	OUT_TEMP register description.	35
Table 36.	STATUS_REG register.	36
Table 37.	STATUS_REG description	36
Table 38.	REFERENCE register.	36
Table 39.	REFERENCE register description	37
Table 40.	FIFO mode configuration	37
Table 41.	FIFO_SRC register	37
Table 42.	FIFO_SRC register description.	37
Table 43.	INT1_CFG register	37
Table 44.	INT1_CFG description	38
Table 45.	INT1_SRC register	38
Table 46.	INT1_SRC description	38
Table 47.	INT1_THS_XH register.	39
Table 48.	INT1_THS_XH description	39
Table 49.	INT1_THS_XL register	39

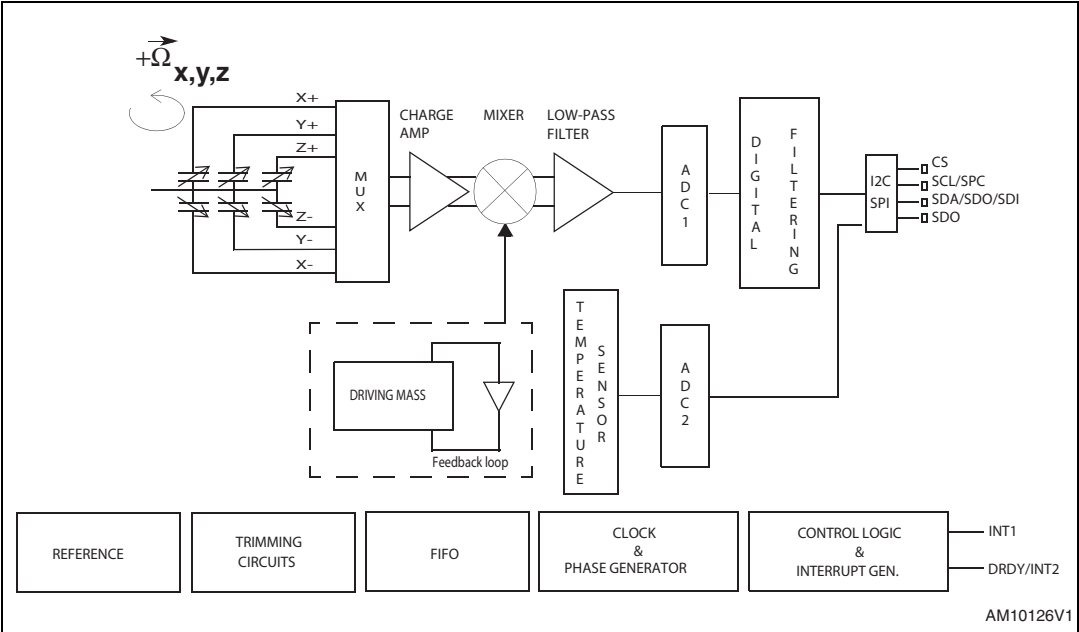
Table 50.	INT1_THS_XL description	39
Table 51.	INT1_THS_YH register	39
Table 52.	INT1_THS_YH description	39
Table 53.	INT1_THS_YL register	39
Table 54.	INT1_THS_YL description	39
Table 55.	INT1_THS_ZH register	40
Table 56.	INT1_THS_ZH description	40
Table 57.	INT1_THS_ZL register	40
Table 58.	INT1_THS_ZL description	40
Table 59.	INT1_DURATION register	40
Table 60.	INT1_DURATION description	40
Table 61.	Document revision history	43

List of figures

Figure 1.	Block diagram	7
Figure 2.	Pin connection	7
Figure 3.	SPI slave timing diagram	11
Figure 4.	I2C slave timing diagram	12
Figure 5.	L3GD20 electrical connections and external component values	15
Figure 6.	Block diagram	16
Figure 7.	Bypass mode	17
Figure 8.	FIFO mode	18
Figure 9.	Stream mode	19
Figure 10.	Bypass-to-stream mode	20
Figure 11.	Trigger stream mode	20
Figure 12.	Read and write protocol	25
Figure 13.	SPI read protocol	26
Figure 14.	Multiple byte SPI read protocol (2-byte example)	26
Figure 15.	SPI write protocol	27
Figure 16.	Multiple byte SPI write protocol (2-byte example)	27
Figure 17.	SPI read protocol in 3-wire mode	28
Figure 18.	INT1_Sel and Out_Sel configuration block diagram	35
Figure 19.	Wait disabled	41
Figure 20.	Wait enabled	41
Figure 21.	LGA-16: mechanical data and package dimensions	42

1 Block diagram and pin description

Figure 1. Block diagram



Note: The vibration of the structure is maintained by drive circuitry in a feedback loop. The sensing signal is filtered and appears as a digital signal at the output.

1.1 Pin description

Figure 2. Pin connection

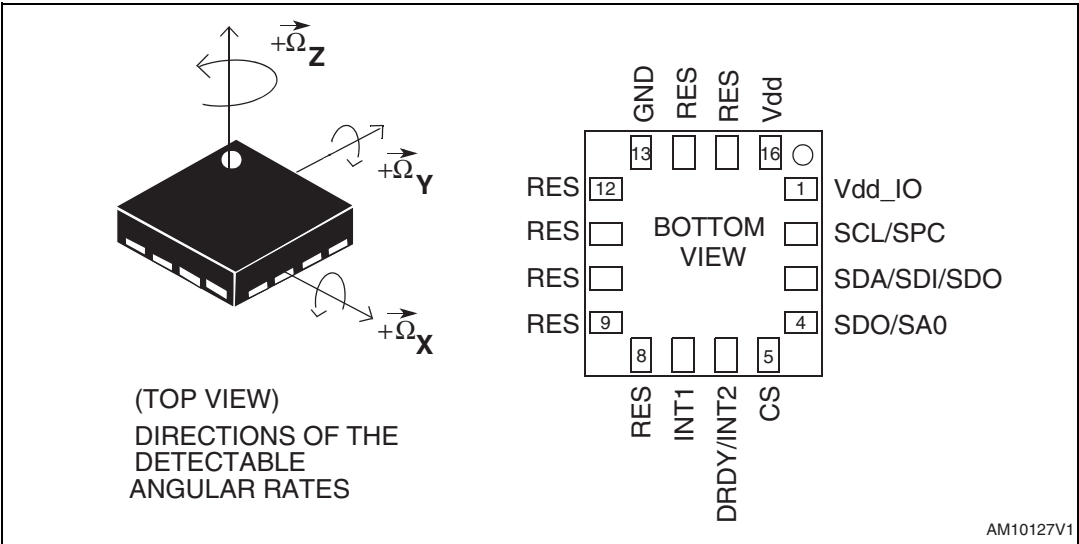


Table 2. Pin description

Pin#	Name	Function
1	Vdd_IO ⁽¹⁾	Power supply for I/O pins
2	SCL SPC	I ² C serial clock (SCL) SPI serial port clock (SPC)
3	SDA SDI SDO	I ² C serial data (SDA) SPI serial data input (SDI) 3-wire interface serial data output (SDO)
4	SDO SA0	SPI serial data output (SDO) I ² C less significant bit of the device address (SA0)
5	CS	I ² C/SPI mode selection (1: SPI idle mode / I ² C communication enabled; 0: SPI communication mode / I ² C disabled)
6	DRDY/INT2	Data ready/FIFO interrupt (Watermark/Overrun/Empty)
7	INT1	Programmable interrupt
8	Reserved	Connect to GND
9	Reserved	Connect to GND
10	Reserved	Connect to GND
11	Reserved	Connect to GND
12	Reserved	Connect to GND
13	GND	0 V supply
14	Reserved	Connect to GND with ceramic capacitor ⁽²⁾
15	Reserved	Connect to Vdd
16	Vdd ⁽³⁾	Power supply

1. 100 nF filter capacitor recommended.

2. 1 nF min value must be guaranteed under 11 V bias condition.

3. 100 nF plus 10 μ F capacitors recommended.

2 Mechanical and electrical specifications

2.1 Mechanical characteristics

@ Vdd = 3.0 V, T = 25 °C unless otherwise noted.

Table 3. Mechanical characteristics⁽¹⁾

Symbol	Parameter	Test condition	Min.	Typ. ⁽²⁾	Max.	Unit
FS	Measurement range	User-selectable		±250		dps
				±500		
				±2000		
So	Sensitivity	FS = 250 dps		8.75		mdps/digit
		FS = 500 dps		17.50		
		FS = 2000 dps		70		
SoDr	Sensitivity change vs. temperature	From -40 °C to +85 °C		±2		%
DVoff	Digital zero-rate level	FS = 250 dps		±10		dps
		FS = 500 dps		±15		
		FS = 2000 dps		±75		
OffDr	Zero-rate level change vs. temperature	FS = 250 dps		±0.03		dps/°C
		FS = 2000 dps		±0.04		dps/°C
NL	Non linearity	Best fit straight line		0.2		% FS
Rn	Rate noise density			0.03		dps / ($\sqrt{\text{Hz}}$)
ODR	Digital output data rate			95/190/ 380/760		Hz
Top	Operating temperature range		-40		+85	°C

1. The product is factory calibrated at 3.0 V. The operational power supply range is specified in [Table 4](#).

2. Typical specifications are not guaranteed.

2.2 Electrical characteristics

@ Vdd =3.0 V, T=25 °C unless otherwise noted.

Table 4. Electrical characteristics ⁽¹⁾

Symbol	Parameter	Test condition	Min.	Typ. ⁽²⁾	Max.	Unit
Vdd	Supply voltage		2.4	3.0	3.6	V
Vdd_IO	I/O pins supply voltage ⁽³⁾		1.71		Vdd+0.1	V
Idd	Supply current			6.1		mA
IddSL	Supply current in sleep mode ⁽⁴⁾	Selectable by digital interface		2		mA
IddPdn	Supply current in power-down mode	Selectable by digital interface		5		μA
VIH	Digital high level input voltage		0.8*Vdd_IO			V
VIL	Digital low level input voltage				0.2*Vdd_IO	V
Top	Operating temperature range		-40		+85	°C

1. The product is factory calibrated at 3.0 V.
2. Typical specifications are not guaranteed.
3. It is possible to remove Vdd maintaining Vdd_IO without blocking the communication busses; in this condition the measurement chain is powered off.
4. Sleep mode introduces a faster turn-on time relative to power-down mode.

2.3 Temperature sensor characteristics

@ Vdd =3.0 V, T=25 °C unless otherwise noted.

Table 5. Electrical characteristics ⁽¹⁾

Symbol	Parameter	Test condition	Min.	Typ. ⁽²⁾	Max.	Unit
TSDr	Temperature sensor output change vs. temperature	-		-1		°C/digit
TODR	Temperature refresh rate			1		Hz
Top	Operating temperature range		-40		+85	°C

1. The product is factory calibrated at 3.0 V.
2. Typical specifications are not guaranteed.

2.4 Communication interface characteristics

2.4.1 SPI - serial peripheral interface

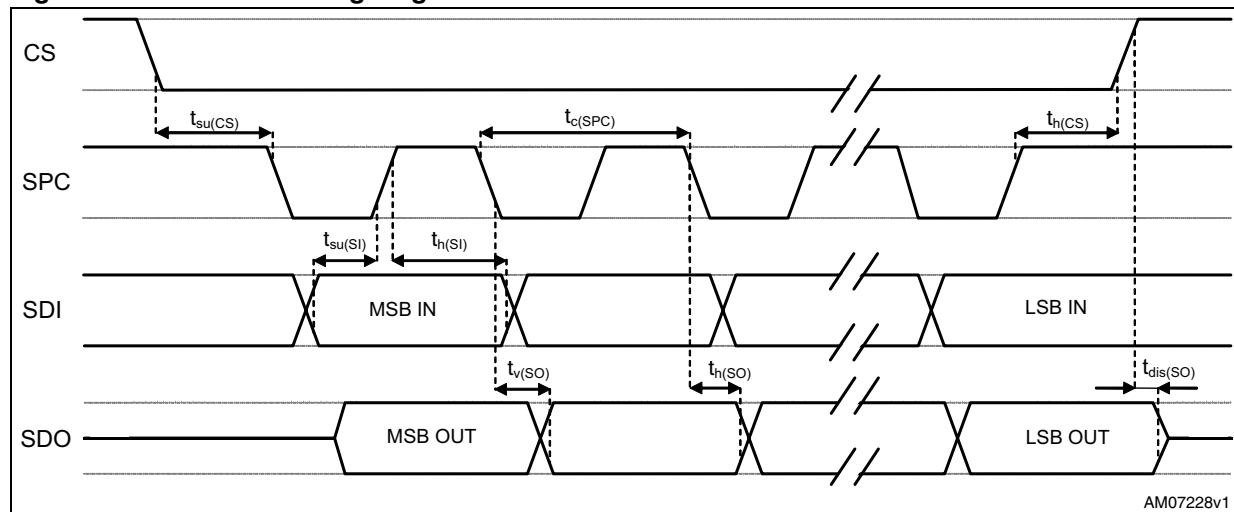
Subject to general operating conditions for V_{DD} and T_{OP}.

Table 6. SPI slave timing values

Symbol	Parameter	Value ⁽¹⁾		Unit
		Min	Max	
t _c (SPC)	SPI clock cycle	100		ns
f _c (SPC)	SPI clock frequency		10	MHz
t _{su} (CS)	CS setup time	5		ns
t _h (CS)	CS hold time	8		
t _{su} (SI)	SDI input setup time	5		
t _h (SI)	SDI input hold time	15		
t _v (SO)	SDO valid output time		50	
t _h (SO)	SDO output hold time	6		
t _{dis} (SO)	SDO output disable time		50	

1. Values are guaranteed at a 10 MHz clock frequency for SPI with both 4 and 3 wires, based on characterization results; not tested in production.

Figure 3. SPI slave timing diagram ^(a)



a. Measurement points are at 0.2·V_{DD_IO} and 0.8·V_{DD_IO}, for both input and output port.

2.4.2 I²C - Inter IC control interface

Subject to general operating conditions for V_{dd} and T_{op}.

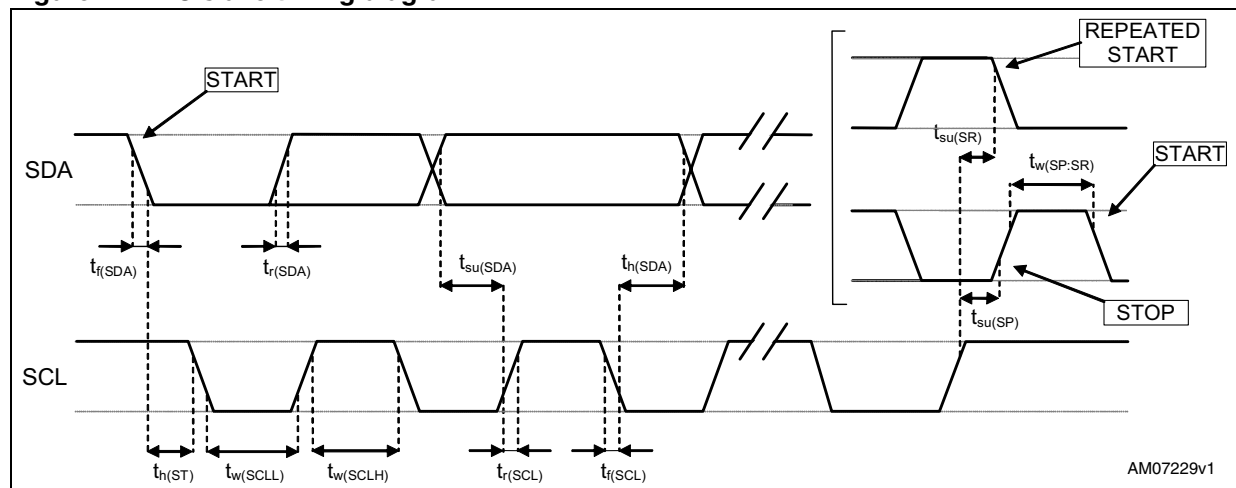
Table 7. I²C slave timing values (TBC)

Symbol	Parameter	I ² C standard mode ⁽¹⁾		I ² C fast mode ⁽¹⁾		Unit
		Min	Max	Min	Max	
f _(SCL)	SCL clock frequency	0	100	0	400	kHz
t _{w(SCLL)}	SCL clock low time	4.7		1.3		μs
t _{w(SCLH)}	SCL clock high time	4.0		0.6		
t _{su(SDA)}	SDA setup time	250		100		ns
t _{h(SDA)}	SDA data hold time	0	3.45	0	0.9	μs
t _{r(SDA)} t _{r(SCL)}	SDA and SCL rise time		1000	20 + 0.1C _b ⁽²⁾	300	ns
t _{f(SDA)} t _{f(SCL)}	SDA and SCL fall time		300	20 + 0.1C _b ⁽²⁾	300	
t _{h(ST)}	START condition hold time	4		0.6		μs
t _{su(SR)}	Repeated START condition setup time	4.7		0.6		
t _{su(SP)}	STOP condition setup time	4		0.6		
t _{w(SP:SR)}	Bus free time between STOP and START condition	4.7		1.3		

1. Data based on standard I²C protocol requirement; not tested in production.

2. C_b = total capacitance of one bus line, in pF.

Figure 4. I²C slave timing diagram (b)



b. Measurement points are at 0.2·V_{dd_IO} and 0.8·V_{dd_IO}, for both ports.

2.5 Absolute maximum ratings

Stresses above those listed as “Absolute maximum ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 8. Absolute maximum ratings

Symbol	Ratings	Maximum value	Unit
Vdd	Supply voltage	-0.3 to 4.8	V
T _{STG}	Storage temperature range	-40 to +125	°C
Sg	Acceleration g for 0.1 ms	10,000	g
ESD	Electrostatic discharge protection	2 (HBM)	kV
		1.5 (CDM)	kV
		200 (MM)	V
Vin	Input voltage on any control pin (CS, SCL/SPC, SDA/SDI/SDO, SDO/SA0)	-0.3 to Vdd_IO +0.3	V

Note: Supply voltage on any pin should never exceed 4.8 V



This is a mechanical shock sensitive device, improper handling can cause permanent damage to the part



This is an ESD sensitive device, improper handling can cause permanent damage to the part

2.6 Terminology

2.6.1 Sensitivity

An angular rate gyroscope is a device that produces a positive-going digital output for counter-clockwise rotation around the sensitive axis considered. Sensitivity describes the gain of the sensor and can be determined by applying a defined angular velocity to it. This value changes very little over temperature and time.

2.6.2 Zero-rate level

Zero-rate level describes the actual output signal if there is no angular rate present. Zero-rate level of precise MEMS sensors is, to some extent, a result of stress to the sensor and therefore zero-rate level can slightly change after mounting the sensor onto a printed circuit board or after exposing it to extensive mechanical stress. This value changes very little over temperature and time.

2.7 Soldering information

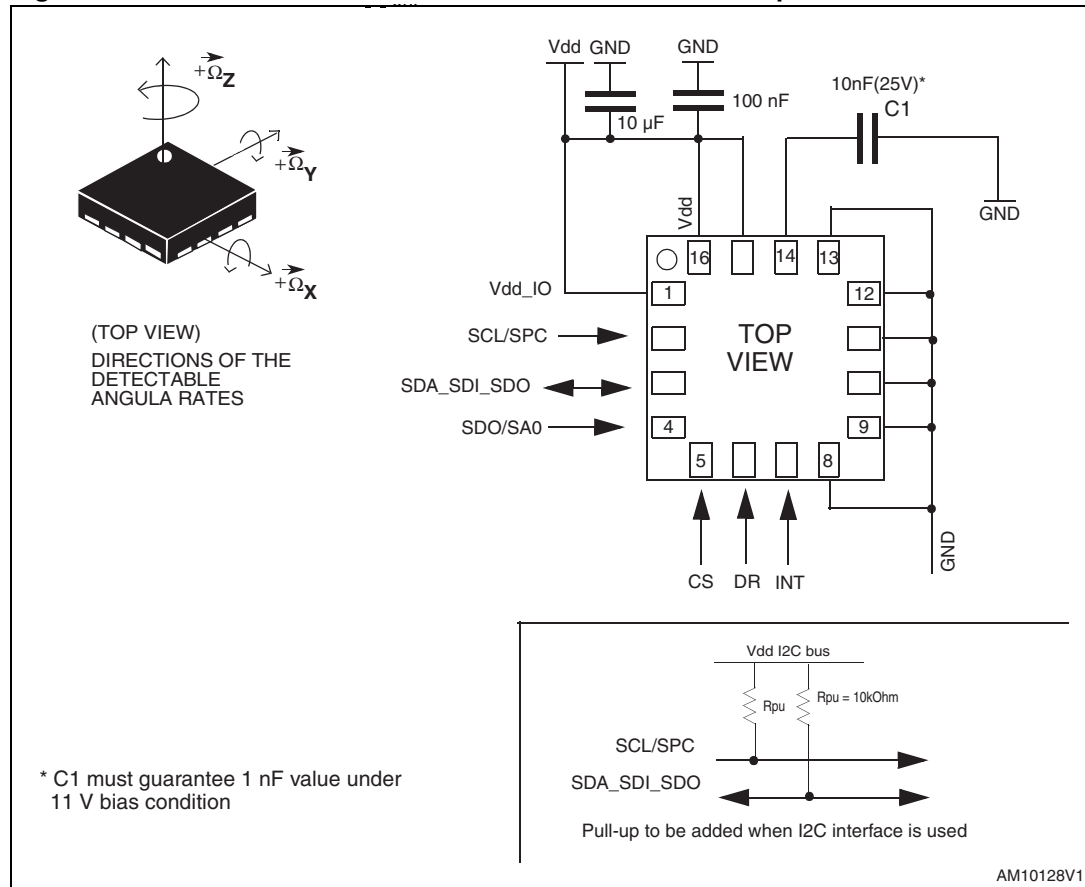
The LGA package is compliant with the ECOPACK[®], RoHS and “Green” standard. It is qualified for soldering heat resistance according to JEDEC J-STD-020.

Leave “Pin 1 Indicator” unconnected during soldering.

Land pattern and soldering recommendations are available at www.st.com/mems.

3 Application hints

Figure 5. L3GD20 electrical connections and external component values



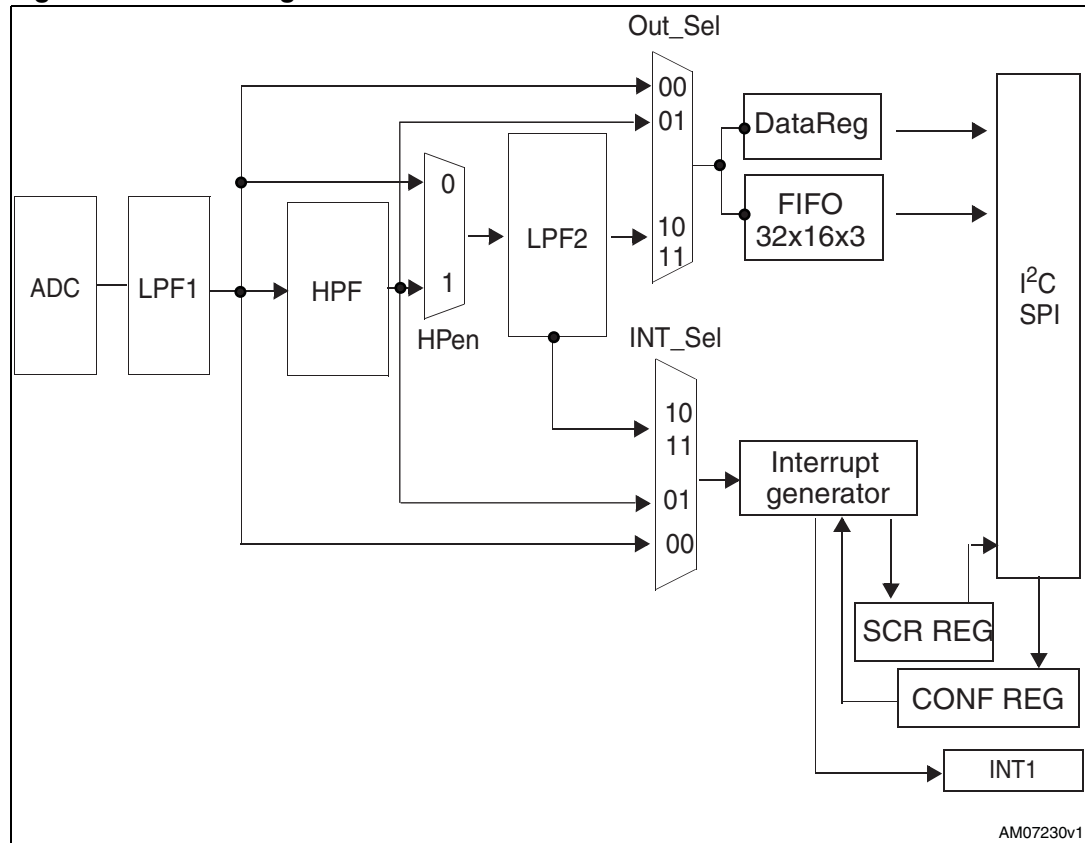
Power supply decoupling capacitors (100 nF + 10 μF) should be placed as near as possible to the device (common design practice).

If Vdd and Vdd_IO are not connected together, 100 nF and 10 μF decoupling capacitors must be placed between Vdd and common ground, and 100 nF between Vdd_IO and common ground. Capacitors should be placed as near as possible to the device (common design practice).

4 Digital main blocks

4.1 Block diagram

Figure 6. Block diagram



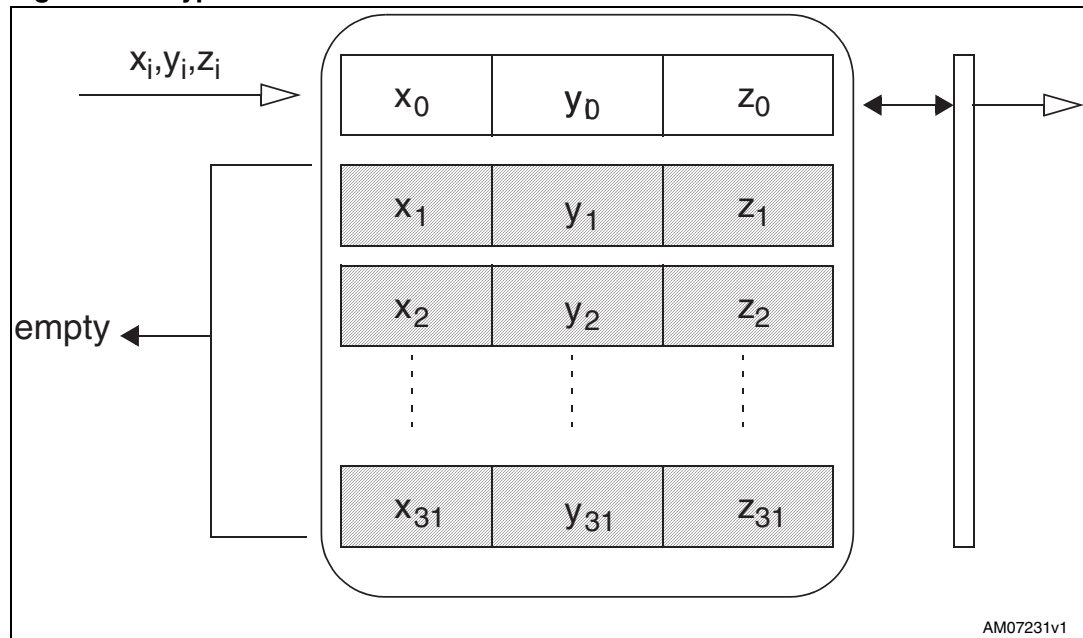
4.2 FIFO

The L3GD20 embeds 32 slots of 16-bit data FIFO for each of the three output channels: yaw, pitch and roll. This allows consistent power saving for the system, since the host processor does not need to continuously poll data from the sensor, but can wake up only when needed and burst the significant data out from the FIFO. This buffer can work accordingly in five different modes: Bypass mode, FIFO mode, Stream mode, Bypass-to-Stream mode and Stream-to-FIFO mode. Each mode is selected by the FIFO_MODE bits in the FIFO_CTRL_REG (2Eh). Programmable Watermark level, FIFO_empty or FIFO_Full events can be enabled to generate dedicated interrupts on the DRDY/INT2 pin (configured through CTRL_REG3 (22h) and event detection information is available in FIFO_SRC_REG (2Fh). Watermark level can be configured to WTM4:0 in FIFO_CTRL_REG (2Eh).

4.2.1 Bypass mode

In Bypass mode, the FIFO is not operational and for this reason it remains empty. As described in [Figure 7](#) below, for each channel only the first address is used. The remaining FIFO slots are empty. When new data is available, the old data is overwritten.

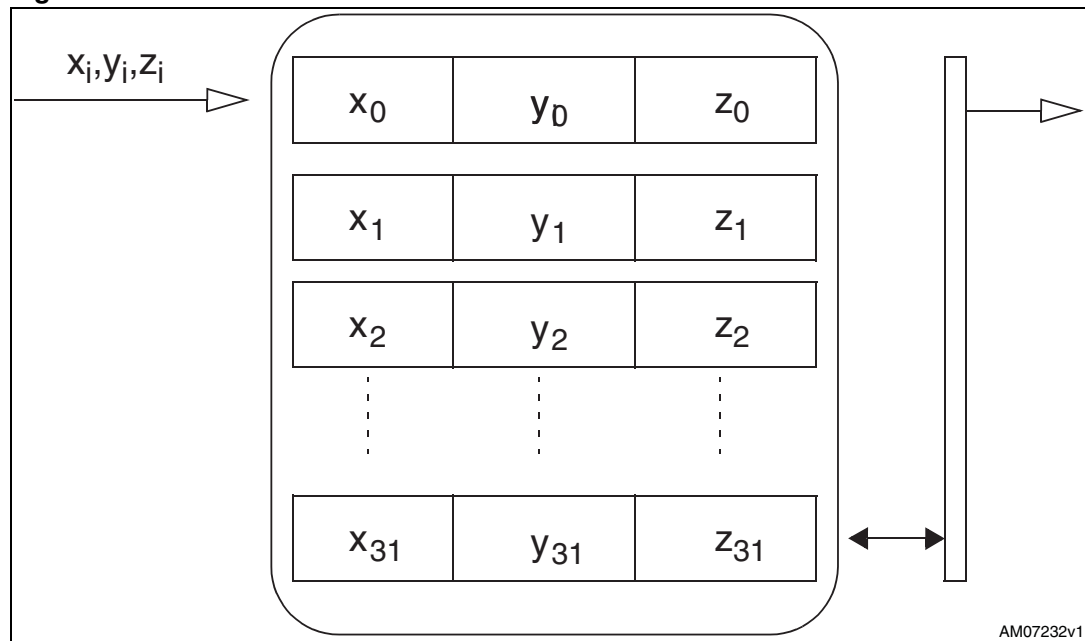
Figure 7. Bypass mode



4.2.2 FIFO mode

In FIFO mode, data from the yaw, pitch and roll channels is stored in the FIFO. A watermark interrupt can be enabled (I2_WMK bit into CTRL_REG3 (22h)) in order to be raised when the FIFO is filled to the level specified in the WTM 4:0 bits of FIFO_CTRL_REG (2Eh). The FIFO continues filling until it is full (32 slots of 16-bit data for yaw, pitch and roll). When full, the FIFO stops collecting data from the input channels. To restart data collection, the FIFO_CTRL_REG (2Eh) must be written back to Bypass mode.

FIFO mode is represented in [Figure 8: FIFO mode](#).

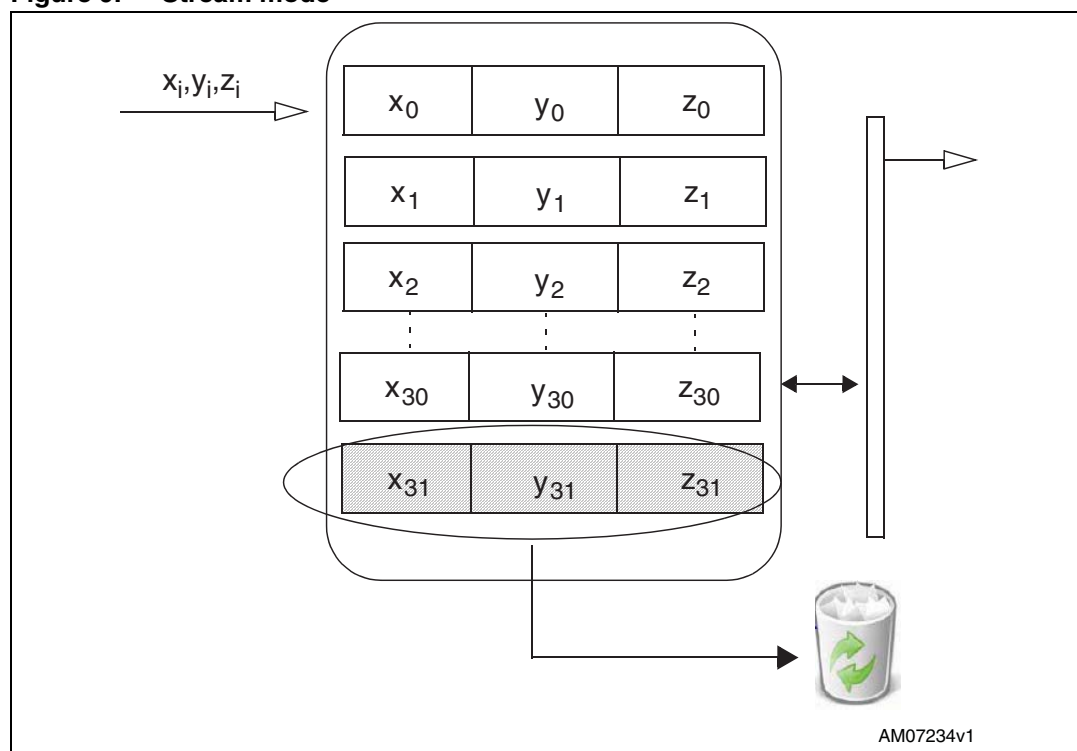
Figure 8. FIFO mode

4.2.3 Stream mode

In Stream mode, data from yaw, pitch and roll measurement are stored in the FIFO. A watermark interrupt can be enabled and set as in the FIFO mode. The FIFO continues filling until it is full (32 slots of 16-bit data for yaw, pitch and roll). When full, the FIFO discards the older data as the new data arrives. Programmable watermark level events can be enabled to generate dedicated interrupts on the DRDY/INT2 pin (configured through CTRL_REG3 (22h)).

Stream mode is represented in [Figure 9: Stream mode](#).

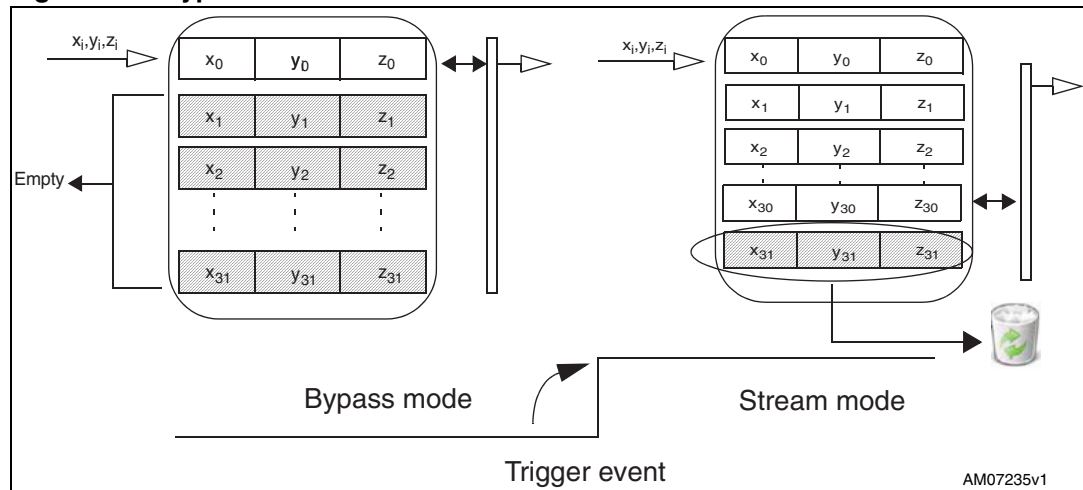
Figure 9. Stream mode



4.2.4 Bypass-to-stream mode

In Bypass-to-stream mode, the FIFO begins operating in Bypass mode and once a trigger event occurs (related to INT1_CFG (30h) register events), the FIFO starts operating in Stream mode. Refer to [Figure 10](#) below.

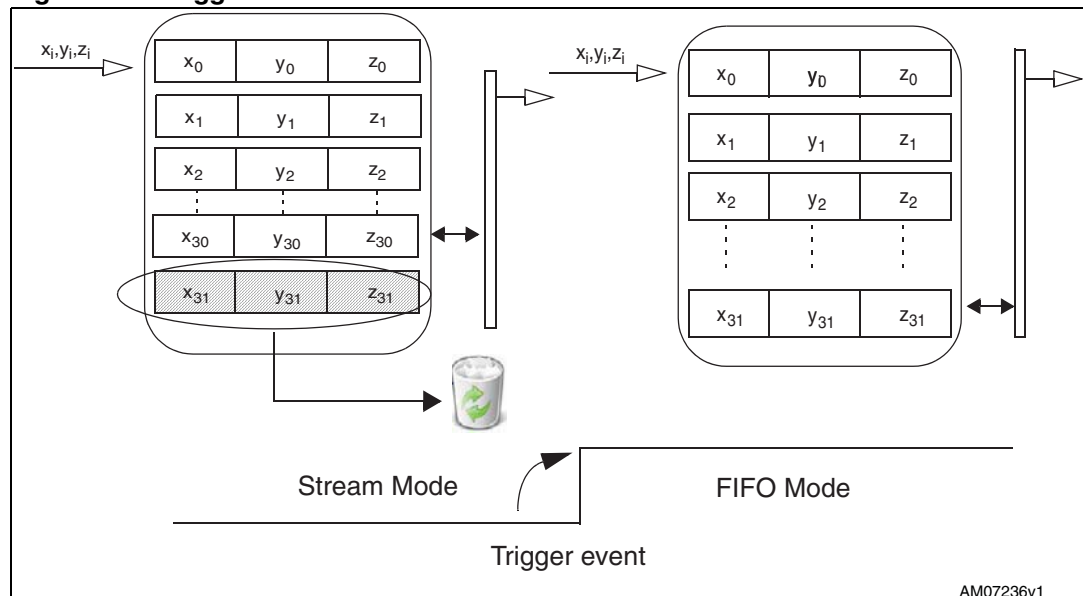
Figure 10. Bypass-to-stream mode



4.2.5 Stream-to-FIFO mode

In Stream-to-FIFO mode, data from yaw, pitch and roll measurement is stored in the FIFO. A watermark interrupt can be enabled on pin DRDY/INT2 by setting the I2_WTM bit in CTRL_REG3 (22h) in order to be raised when the FIFO is filled to the level specified in the WTM4:0 bits of FIFO_CTRL_REG (2Eh). The FIFO continues filling until it is full (32 slots of 16-bit data for yaw, pitch and roll). When full, the FIFO discards the older data as the new data arrives. Once a trigger event occurs (related to INT1_CFG (30h) register events), the FIFO starts operating in FIFO mode. Refer to [Figure 11](#) below.

Figure 11. Trigger stream mode



4.2.6 Retrieve data from FIFO

FIFO data is read through OUT_X (Addr reg 28h,29h), OUT_Y (Addr reg 2Ah,2Bh) and OUT_Z (Addr reg 2Ch,2Dh). When the FIFO is in Stream, Trigger or FIFO mode, a read operation of the OUT_X, OUT_Y or OUT_Z registers provides the data stored in the FIFO. Each time data is read from the FIFO, the oldest pitch, roll and yaw data is placed in the OUT_X, OUT_Y and OUT_Z registers and both single read and read_burst (X,Y & Z with auto-incrementing address) operations can be used. When data included in OUT_Z_H (2Dh) is read, the system restarts to read information from addr OUT_X_L (28h).

5 Digital interfaces

The registers embedded in the L3GD20 may be accessed through both the I²C and SPI serial interfaces. The latter may be SW-configured to operate either in 3-wire or 4-wire interface mode.

The serial interfaces are mapped onto the same pins. To select/exploit the I²C interface, the CS line must be tied high (i.e connected to Vdd_IO).

Table 9. Serial interface pin description

Pin name	Pin description
CS	I ² C/SPI mode selection (1: SPI idle mode / I ² C communication enabled; 0: SPI communication mode / I ² C disabled)
SCL/SPC	I ² C serial clock (SCL) SPI serial port clock (SPC)
SDA/SDI/SDO	I ² C serial data (SDA) SPI serial data input (SDI) 3-wire interface serial data output (SDO)
SDO	SPI serial data output (SDO) I ² C less significant bit of the device address

5.1 I²C serial interface

The L3GD20 I²C is a bus slave. The I²C is employed to write data into registers whose content can also be read back.

The relevant I²C terminology is given in the table below.

Table 10. I²C terminology

Term	Description
Transmitter	The device which sends data to the bus
Receiver	The device which receives data from the bus
Master	The device which initiates a transfer, generates clock signals and terminates a transfer
Slave	The device addressed by the master

There are two signals associated with the I²C bus: the serial clock line (SCL) and the serial data line (SDA). The latter is a bidirectional line used for sending and receiving the data to/from the interface. Both lines must be connected to Vdd_IO through external pull-up resistors. When the bus is free, both lines are high.

The I²C interface is compliant with fast mode (400 kHz) I²C standards as well as with normal mode.

5.1.1 I²C operation

The transaction on the bus is started through a START (ST) signal. A START condition is defined as a HIGH to LOW transition on the data line while the SCL line is held HIGH. After this has been transmitted by the Master, the bus is considered busy. The next byte of data transmitted after the start condition contains the address of the slave in the first 7 bits and the eighth bit tells whether the Master is receiving data from the slave or transmitting data to the slave. When an address is sent, each device in the system compares the first seven bits after a start condition with its address. If they match, the device considers itself addressed by the Master.

The Slave Address (SAD) associated with the L3GD20 is 110101xb. The **SDO** pin can be used to modify the less significant bit of the device address. If the SDO pin is connected to voltage supply, LSb is '1' (address 1101011b). Otherwise, if the SDO pin is connected to ground, the LSb value is '0' (address 1101010b). This solution allows to connect and address two different gyroscopes to the same I²C bus.

Data transfer with acknowledge is mandatory. The transmitter must release the SDA line during the acknowledge pulse. The receiver must then pull the data line LOW so that it remains stable low during the HIGH period of the acknowledge clock pulse. A receiver which has been addressed is obligated to generate an acknowledge after each byte of data received.

The I²C embedded in the L3GD20 behaves like a slave device and the following protocol must be adhered to. After the start condition (ST) a slave address is sent, once a slave acknowledge (SAK) has been returned, an 8-bit sub-address is transmitted: the 7 LSb represent the actual register address while the MSb enables address auto-increment. If the MSb of the SUB field is 1, the SUB (register address) will be automatically incremented to allow multiple data read/write.

The slave address is completed with a Read/Write bit. If the bit was '1' (Read), a repeated START (SR) condition must be issued after the two sub-address bytes; if the bit is '0' (Write) the master will transmit to the slave with direction unchanged. [Table 11](#) explains how the SAD+Read/Write bit pattern is composed, listing all the possible configurations.

Table 11. SAD+read/write patterns

Command	SAD[6:1]	SAD[0] = SDO	R/W	SAD+R/W
Read	110101	0	1	11010101 (D1h)
Write	110101	0	0	11010100 (D0h)
Read	110101	1	1	11010111 (D3h)
Write	110101	1	0	11010110 (D2h)

Table 12. Transfer when master is writing one byte to slave

Master	ST	SAD + W		SUB		DATA		SP
Slave			SAK		SAK		SAK	

Table 13. Transfer when master is writing multiple bytes to slave

Master	ST	SAD + W		SUB		DATA		DATA		SP
Slave			SAK		SAK		SAK		SAK	

Table 14. Transfer when master is receiving (reading) one byte of data from slave

Master	ST	SAD + W		SUB		SR	SAD + R			NMAK	SP
Slave			SAK		SAK			SAK	DATA		

Table 15. Transfer when master is receiving (reading) multiple bytes of data from slave

Master	ST	SAD+W		SUB		SR	SAD+R			MAK		MAK		NMAK	SP
Slave			SAK		SAK			SAK	DATA		DATA		DATA		

Data is transmitted in byte format (DATA). Each data transfer contains 8 bits. The number of bytes sent per transfer is unlimited. Data is transferred with the most significant bit (MSb) first. If a receiver cannot receive another complete byte of data until it has performed some other function, it can hold the clock line, SCL, LOW to force the transmitter into a wait state. Data transfer only continues when the receiver is ready for another byte and releases the data line. If a slave receiver does not acknowledge the slave address (i.e. it is not able to receive because it is performing some real-time function) the data line must be left HIGH by the slave. The Master can then abort the transfer. A LOW to HIGH transition on the SDA line while the SCL line is HIGH is defined as a STOP condition. Each data transfer must be terminated by the generation of a STOP (SP) condition.

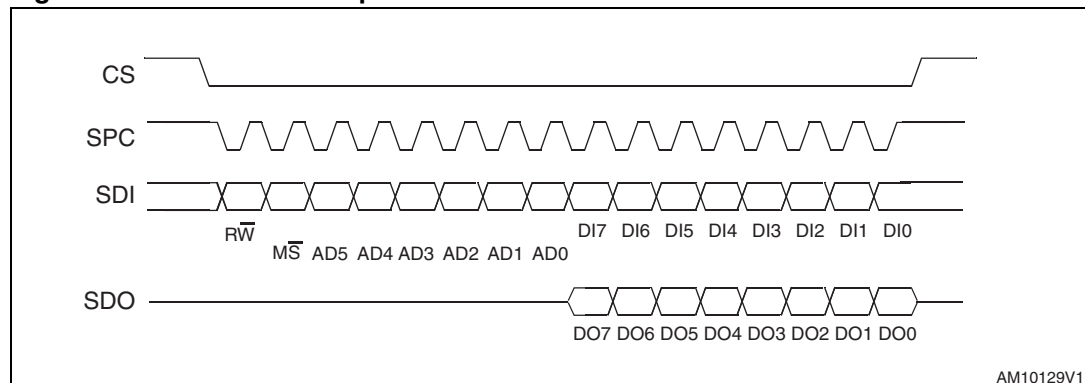
In order to read multiple bytes, it is necessary to assert the most significant bit of the sub-address field. In other words, SUB(7) must be equal to '1' while SUB(6-0) represents the address of the first register to be read.

In the communication format presented, MAK is Master Acknowledge and NMAK is No Master Acknowledge.

5.2 SPI bus interface

The SPI is a bus slave. The SPI allows writing and reading the registers of the device.

The serial interface interacts with the outside world through 4 wires: **CS**, **SPC**, **SDI** and **SDO**.

Figure 12. Read and write protocol

CS is the Serial Port Enable and is controlled by the SPI master. It goes low at the start of the transmission and goes back high at the end. **SPC** is the Serial Port Clock and it is controlled by the SPI master. It is stopped high when **CS** is high (no transmission). **SDI** and **SDO** are respectively the Serial Port Data Input and Output. Those lines are driven at the falling edge of **SPC** and should be captured at the rising edge of **SPC**.

Both the Read Register and Write Register commands are completed in 16 clock pulses or in multiples of 8 in case of multiple bytes read/write. Bit duration is the time between two falling edges of **SPC**. The first bit (bit 0) starts at the first falling edge of **SPC** after the falling edge of **CS** while the last bit (bit 15, bit 23, ...) starts at the last falling edge of **SPC** just before the rising edge of **CS**.

bit 0: $\overline{RW}$ bit. When 0, the data $DI(7:0)$ is written to the device. When 1, the data $DO(7:0)$ from the device is read. In the latter case, the chip will drive **SDO** at the start of bit 8.

bit 1: $\overline{MS}$ bit. When 0, the address remains unchanged in multiple read/write commands. When 1, the address will be auto-incremented in multiple read/write commands.

bit 2-7: address $AD(5:0)$. This is the address field of the indexed register.

bit 8-15: data $DI(7:0)$ (write mode). This is the data that will be written to the device (MSb first).

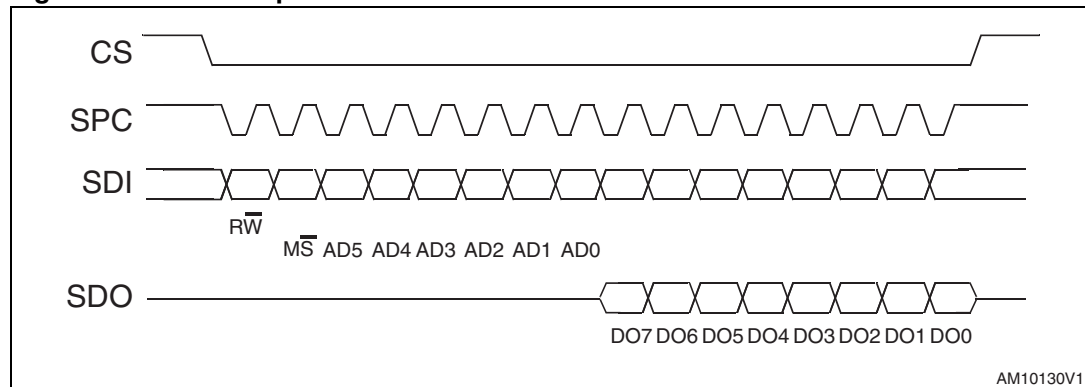
bit 8-15: data $DO(7:0)$ (read mode). This is the data that will be read from the device (MSb first).

In multiple read/write commands, further blocks of 8 clock periods will be added. When the $\overline{MS}$ bit is 0, the address used to read/write data remains the same for every block. When the $\overline{MS}$ bit is 1, the address used to read/write data is incremented at every block.

The function and the behavior of **SDI** and **SDO** remain unchanged.

5.2.1 SPI read

Figure 13. SPI read protocol



The SPI read command is performed with 16 clock pulses. The multiple byte read command is performed by adding blocks of 8 clock pulses to the previous one.

bit 0: READ bit. The value is 1.

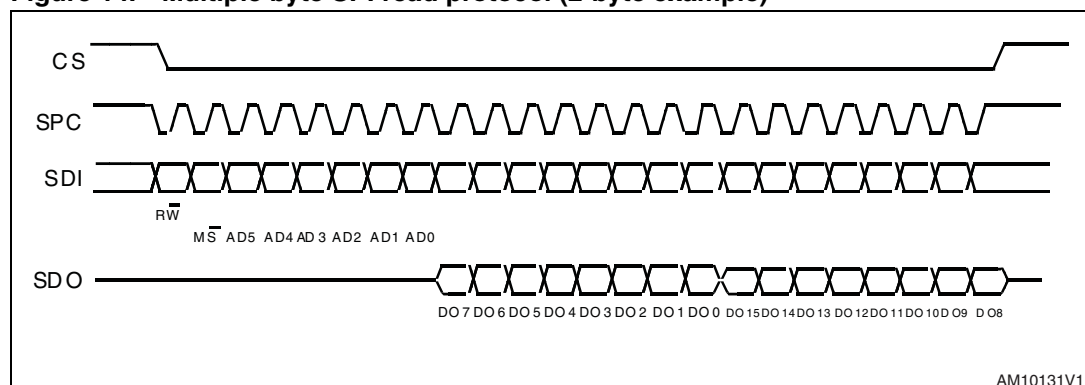
bit 1: $\overline{MS}$ bit. When 0 do not increment address; when 1 increment address in multiple reading.

bit 2-7: address AD(5:0). This is the address field of the indexed register.

bit 8-15: data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

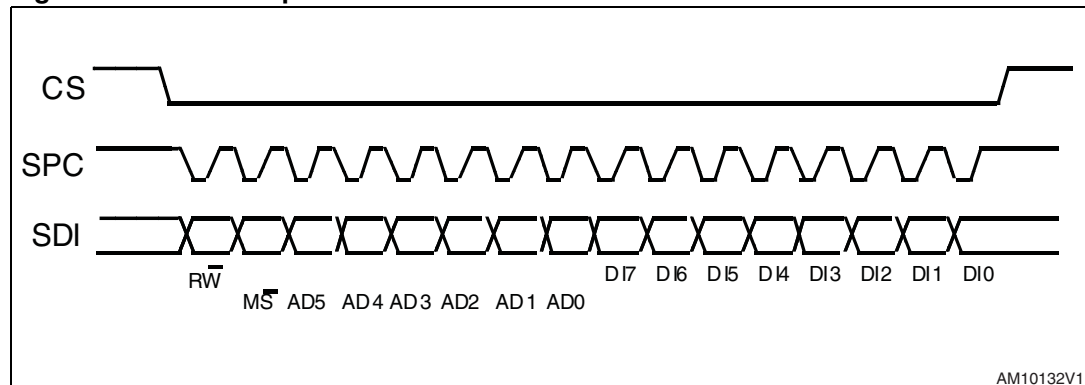
bit 16-... : data DO(...-8). Further data in multiple byte reading.

Figure 14. Multiple byte SPI read protocol (2-byte example)



5.2.2 SPI write

Figure 15. SPI write protocol



The SPI Write command is performed with 16 clock pulses. The multiple byte write command is performed by adding blocks of 8 clock pulses to the previous one.

bit 0: WRITE bit. The value is 0.

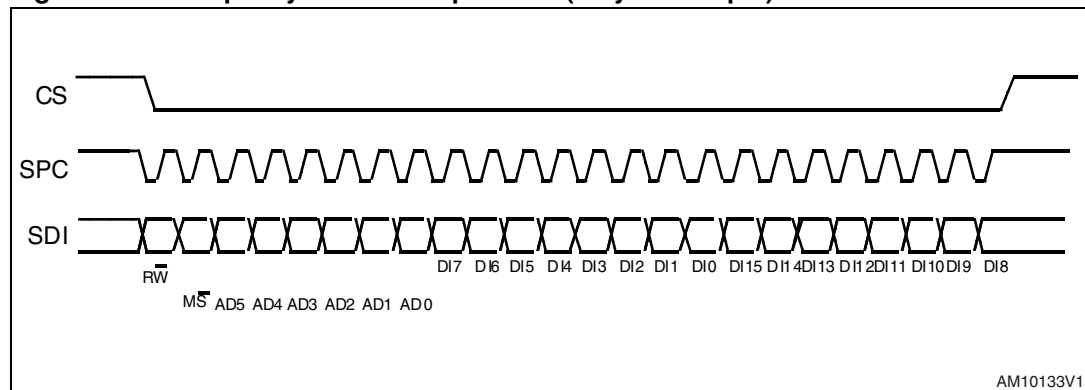
bit 1: $\overline{MS}$ bit. When 0, do not increment address; when 1, increment address in multiple writing.

bit 2-7: address AD(5:0). This is the address field of the indexed register.

bit 8-15: data DI(7:0) (write mode). This is the data that will be written to the device (MSb first).

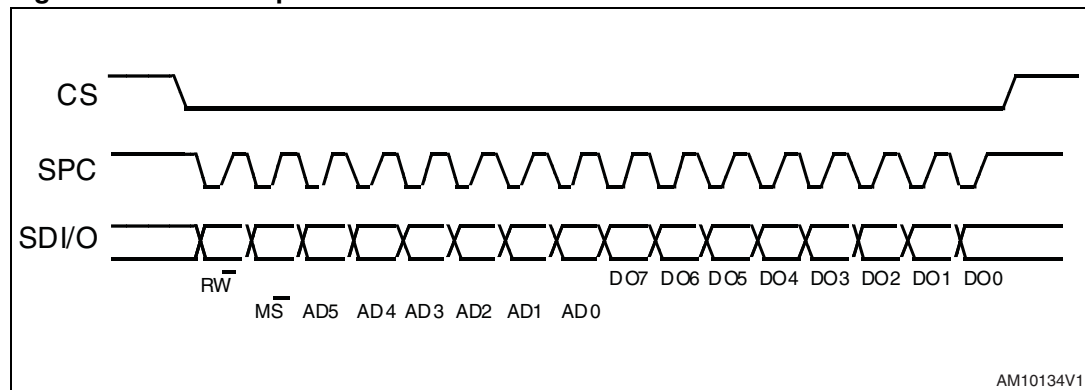
bit 16-... : data DI(...-8). Further data in multiple byte writing.

Figure 16. Multiple byte SPI write protocol (2-byte example)



5.2.3 SPI read in 3-wire mode

3-wire mode is entered by setting the bit SIM (SPI serial interface mode selection) to '1' in CTRL_REG2.

Figure 17. SPI read protocol in 3-wire mode

The SPI Read command is performed with 16 clock pulses:

bit 0: READ bit. The value is 1.

bit 1: $\overline{MS}$ bit. When 0, do not increment address; when 1, increment address in multiple reading.

bit 2-7: address AD(5:0). This is the address field of the indexed register.

bit 8-15: data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

Multiple read command is also available in 3-wire mode.

6 Output register mapping

The table below provides a listing of the 8-bit registers embedded in the device, and the related addresses:

Table 16. Register address map

Name	Type	Register address		Default
		Hex	Binary	
Reserved	-	00-0E	-	-
WHO_AM_I	r	0F	000 1111	11010100
Reserved	-	10-1F	-	-
CTRL_REG1	rw	20	010 0000	00000111
CTRL_REG2	rw	21	010 0001	00000000
CTRL_REG3	rw	22	010 0010	00000000
CTRL_REG4	rw	23	010 0011	00000000
CTRL_REG5	rw	24	010 0100	00000000
REFERENCE	rw	25	010 0101	00000000
OUT_TEMP	r	26	010 0110	output
STATUS_REG	r	27	010 0111	output
OUT_X_L	r	28	010 1000	output
OUT_X_H	r	29	010 1001	output
OUT_Y_L	r	2A	010 1010	output
OUT_Y_H	r	2B	010 1011	output
OUT_Z_L	r	2C	010 1100	output
OUT_Z_H	r	2D	010 1101	output
FIFO_CTRL_REG	rw	2E	010 1110	00000000
FIFO_SRC_REG	r	2F	010 1111	output
INT1_CFG	rw	30	011 0000	00000000
INT1_SRC	r	31	011 0001	output
INT1_TSH_XH	rw	32	011 0010	00000000
INT1_TSH_XL	rw	33	011 0011	00000000
INT1_TSH_YH	rw	34	011 0100	00000000
INT1_TSH_YL	rw	35	011 0101	00000000
INT1_TSH_ZH	rw	36	011 0110	00000000
INT1_TSH_ZL	rw	37	011 0111	00000000
INT1_DURATION	rw	38	011 1000	00000000

Registers marked as *Reserved* must not be changed. Writing to these registers may cause permanent damage to the device.

The content of the registers that are loaded at boot should not be changed. They contain the factory calibration values. Their content is automatically restored when the device is powered up.

7 Register description

The device contains a set of registers which are used to control its behavior and to retrieve angular rate data. The register address, consisting of 7 bits, is used to identify them and to write the data through the serial interface.

7.1 WHO_AM_I (0Fh)

Table 17. WHO_AM_I register

1	1	0	1	0	1	0	0
---	---	---	---	---	---	---	---

Device identification register.

7.2 CTRL_REG1 (20h)

Table 18. CTRL_REG1 register

DR1	DR0	BW1	BW0	PD	Zen	Xen	Yen
-----	-----	-----	-----	----	-----	-----	-----

Table 19. CTRL_REG1 description

DR1-DR0	Output data rate selection. Refer to Table 20
BW1-BW0	Bandwidth selection. Refer to Table 20
PD	Power-down mode enable. Default value: 0 (0: power-down mode, 1: normal mode or sleep mode)
Zen	Z axis enable. Default value: 1 (0: Z axis disabled; 1: Z axis enabled)
Yen	Y axis enable. Default value: 1 (0: Y axis disabled; 1: Y axis enabled)
Xen	X axis enable. Default value: 1 (0: X axis disabled; 1: X axis enabled)

DR<1:0> is used for ODR selection. **BW <1:0>** is used for Bandwidth selection.

In the [Table 20](#) all frequencies resulting in combinations of DR / BW bits are reported.

Table 20. DR and BW configuration setting

DR <1:0>	BW <1:0>	ODR [Hz]	Cut-Off
00	00	95	12.5
00	01	95	25
00	10	95	25

Table 20. DR and BW configuration setting (continued)

DR <1:0>	BW <1:0>	ODR [Hz]	Cut-Off
00	11	95	25
01	00	190	12.5
01	01	190	25
01	10	190	50
01	11	190	70
10	00	380	20
10	01	380	25
10	10	380	50
10	11	380	100
11	00	760	30
11	01	760	35
11	10	760	50
11	11	760	100

A combination of **PD**, **Zen**, **Yen**, **Xen** is used to set device to different modes (power-down / normal / sleep mode) in accordance with [Table 21](#) below.

Table 21. Power mode selection configuration

Mode	PD	Zen	Yen	Xen
Power-down	0	-	-	-
Sleep	1	0	0	0
Normal	1	-	-	-

7.3 CTRL_REG2 (21h)

Table 22. CTRL_REG2 register

0 ⁽¹⁾	0 ⁽¹⁾	HPM1	HPM1	HPCF3	HPCF2	HPCF1	HPCF0
------------------	------------------	------	------	-------	-------	-------	-------

1. These bits must be set to '0' to ensure proper operation of the device

Table 23. CTRL_REG2 description

HPM1-HPM0	High-pass filter mode selection. Default value: 00 Refer to Table 24
HPCF3-HPCF0	High-pass filter cutoff frequency selection Refer to Table 25

Table 24. High-pass filter mode configuration

HPM1	HPM0	High-pass filter mode
0	0	Normal mode (reset reading HP_RESET_FILTER)
0	1	Reference signal for filtering
1	0	Normal mode
1	1	Autoreset on interrupt event

Table 25. High-pass filter cut off frequency configuration [Hz]

HPCF3-0	ODR=95 Hz	ODR=190 Hz	ODR=380 Hz	ODR=760 Hz
0000	7.2	13.5	27	51.4
0001	3.5	7.2	13.5	27
0010	1.8	3.5	7.2	13.5
0011	0.9	1.8	3.5	7.2
0100	0.45	0.9	1.8	3.5
0101	0.18	0.45	0.9	1.8
0110	0.09	0.18	0.45	0.9
0111	0.045	0.09	0.18	0.45
1000	0.018	0.045	0.09	0.18
1001	0.009	0.018	0.045	0.09

7.4 CTRL_REG3 (22h)

Table 26. CTRL_REG1 register

I1_Int1	I1_Boot	H_Lactive	PP_OD	I2_DRDY	I2_WTM	I2_ORun	I2_Empty
---------	---------	-----------	-------	---------	--------	---------	----------

Table 27. CTRL_REG3 description

I1_Int1	Interrupt enable on INT1 pin. Default value 0. (0: disable; 1: enable)
I1_Boot	Boot status available on INT1. Default value 0. (0: disable; 1: enable)
H_Lactive	Interrupt active configuration on INT1. Default value 0. (0: high; 1: low)
PP_OD	Push-pull / Open drain. Default value: 0. (0: push-pull; 1: open drain)
I2_DRDY	Data-ready on DRDY/INT2. Default value 0. (0: disable; 1: enable)
I2_WTM	FIFO watermark interrupt on DRDY/INT2. Default value: 0. (0: disable; 1: enable)
I2_ORun	FIFO overrun interrupt on DRDY/INT2. Default value: 0. (0: disable; 1: enable)
I2_Empty	FIFO empty interrupt on DRDY/INT2. Default value: 0. (0: disable; 1: enable)

7.5 CTRL_REG4 (23h)

Table 28. CTRL_REG4 register

BDU	BLE	FS1	FS0	-	0 ⁽¹⁾	0 ⁽¹⁾	SIM
-----	-----	-----	-----	---	------------------	------------------	-----

1. This value must not be changed.

Table 29. CTRL_REG4 description

BDU	Block data update. Default value: 0 (0: continuous update; 1: output registers not updated until MSb and LSb reading)
BLE	Big/little endian data selection. Default value 0. (0: Data LSb @ lower address; 1: Data MSb @ lower address)
FS1-FS0	Full scale selection. Default value: 00 (00: 250 dps; 01: 500 dps; 10: 2000 dps; 11: 2000 dps)
SIM	SPI serial interface mode selection. Default value: 0 (0: 4-wire interface; 1: 3-wire interface).

7.6 CTRL_REG5 (24h)

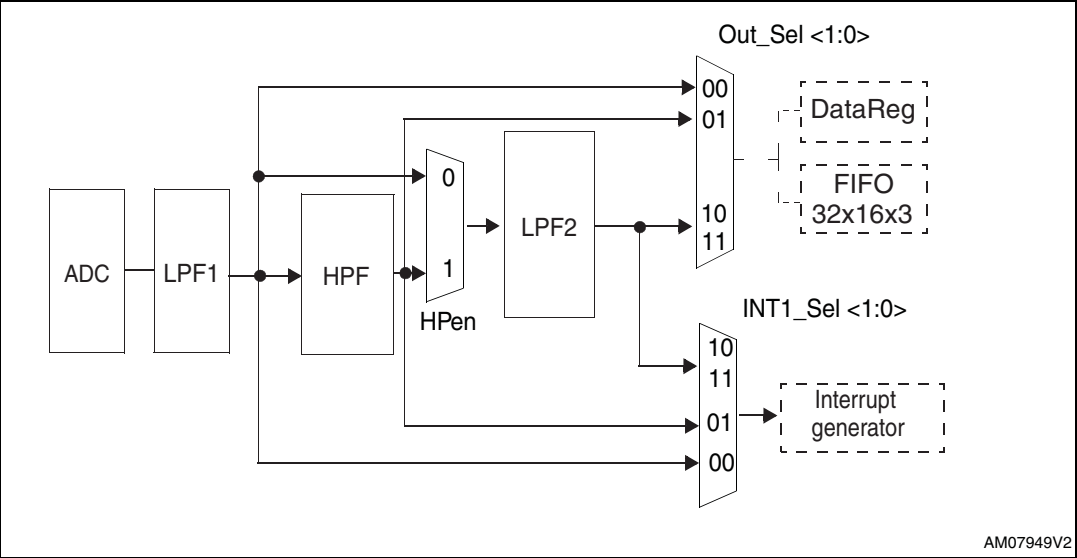
Table 30. CTRL_REG5 register

BOOT	FIFO_EN	--	HPen	INT1_Sel1	INT1_Sel0	Out_Sel1	Out_Sel0
------	---------	----	------	-----------	-----------	----------	----------

Table 31. CTRL_REG5 description

BOOT	Reboot memory content. Default value: 0 (0: normal mode; 1: reboot memory content)
FIFO_EN	FIFO enable. Default value: 0 (0: FIFO disable; 1: FIFO Enable)
HPen	High-pass filter enable. Default value: 0 (0: HPF disabled; 1: HPF enabled See Figure 20)
INT1_Sel1- INT1_Sel0	INT1 selection configuration. Default value: 0 (See Figure 20)
Out_Sel1- Out_Sel0	Out selection configuration. Default value: 0 (See Figure 20)

Figure 18. INT1_Sel and Out_Sel configuration block diagram



7.7 REFERENCE/DATACAPTURE (25h)

Table 32. REFERENCE register

Ref7	Ref6	Ref5	Ref4	Ref3	Ref2	Ref1	Ref0
------	------	------	------	------	------	------	------

Table 33. REFERENCE register description

Ref 7-Ref0	Reference value for interrupt generation. Default value: 0
------------	--

7.8 OUT_TEMP (26h)

Table 34. OUT_TEMP register

Temp7	Temp6	Temp5	Temp4	Temp3	Temp2	Temp1	Temp0
-------	-------	-------	-------	-------	-------	-------	-------

Table 35. OUT_TEMP register description

Temp7-Temp0	Temperature data
-------------	------------------

Temperature data (1LSB/deg - 8-bit resolution). The value is expressed as two's complement.

7.9 STATUS_REG (27h)

Table 36. STATUS_REG register

ZYXOR	ZOR	YOR	XOR	ZYXDA	ZDA	YDA	XDA
-------	-----	-----	-----	-------	-----	-----	-----

Table 37. STATUS_REG description

ZYXOR	X, Y, Z -axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data has overwritten the previous data before it was read)
ZOR	Z axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the Z-axis has overwritten the previous data)
YOR	Y axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the Y-axis has overwritten the previous data)
XOR	X axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the X-axis has overwritten the previous data)
ZYXDA	X, Y, Z -axis new data available. Default value: 0 (0: a new set of data is not yet available; 1: a new set of data is available)
ZDA	Z axis new data available. Default value: 0 (0: new data for the Z-axis is not yet available; 1: new data for the Z-axis is available)
YDA	Y axis new data available. Default value: 0 (0: new data for the Y-axis is not yet available; 1: new data for the Y-axis is available)
XDA	X axis new data available. Default value: 0 (0: new data for the X-axis is not yet available; 1: new data for the X-axis is available)

7.10 OUT_X_L (28h), OUT_X_H (29h)

X-axis angular rate data. The value is expressed as two's complement.

7.11 OUT_Y_L (2Ah), OUT_Y_H (2Bh)

Y-axis angular rate data. The value is expressed as two's complement.

7.12 OUT_Z_L (2Ch), OUT_Z_H (2Dh)

Z-axis angular rate data. The value is expressed as two's complement.

7.13 FIFO_CTRL_REG (2Eh)

Table 38. REFERENCE register

FM2	FM1	FM0	WTM4	WTM3	WTM2	WTM1	WTM0
-----	-----	-----	------	------	------	------	------

Table 39. REFERENCE register description

FM2-FM0	FIFO mode selection. Default value: 00 (see Table 40)
WTM4-WTM0	FIFO threshold. Watermark level setting

Table 40. FIFO mode configuration

FM2	FM1	FM0	FIFO mode
0	0	0	Bypass mode
0	0	1	FIFO mode
0	1	0	Stream mode
0	1	1	Stream-to-FIFO mode
1	0	0	Bypass-to-Stream mode

7.14 FIFO_SRC_REG (2Fh)

Table 41. FIFO_SRC register

WTM	OV RN	EMPTY	FSS4	FSS3	FSS2	FSS1	FSS0
-----	-------	-------	------	------	------	------	------

Table 42. FIFO_SRC register description

WTM	Watermark status. (0: FIFO filling is lower than WTM level; 1: FIFO filling is equal or higher than WTM level)
OV RN	Overflow bit status. (0: FIFO is not completely filled; 1: FIFO is completely filled)
EMPTY	FIFO empty bit. (0: FIFO not empty; 1: FIFO empty)
FSS4-FSS1	FIFO stored data level

7.15 INT1_CFG (30h)

Table 43. INT1_CFG register

AND/OR	LIR	ZHIE	ZLIE	YHIE	YLIE	XHIE	XLIE
--------	-----	------	------	------	------	------	------

Table 44. INT1_CFG description

AND/OR	AND/OR combination of interrupt events. Default value: 0 (0: OR combination of interrupt events 1: AND combination of interrupt events)
LIR	Latch interrupt request. Default value: 0 (0: interrupt request not latched; 1: interrupt request latched) Cleared by reading INT1_SRC reg.
ZHIE	Enable interrupt generation on Z high event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured value higher than preset threshold)
ZLIE	Enable interrupt generation on Z low event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured value lower than preset threshold)
YHIE	Enable interrupt generation on Y high event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured value higher than preset threshold)
YLIE	Enable interrupt generation on Y low event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured value lower than preset threshold)
XHIE	Enable interrupt generation on X high event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured value higher than preset threshold)
XLIE	Enable interrupt generation on X low event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured value lower than preset threshold)

7.16 INT1_SRC (31h)

Interrupt source register. Read only register.

Table 45. INT1_SRC register

0	IA	ZH	ZL	YH	YL	XH	XL
---	----	----	----	----	----	----	----

Table 46. INT1_SRC description

IA	Interrupt active. Default value: 0 (0: no interrupt has been generated; 1: one or more interrupts have been generated)
ZH	Z high. Default value: 0 (0: no interrupt, 1: Z high event has occurred)
ZL	Z low. Default value: 0 (0: no interrupt; 1: Z low event has occurred)
YH	Y high. Default value: 0 (0: no interrupt, 1: Y high event has occurred)
YL	Y low. Default value: 0 (0: no interrupt, 1: Y low event has occurred)
XH	X high. Default value: 0 (0: no interrupt, 1: X High event has occurred)
XL	X low. Default value: 0 (0: no interrupt, 1: X Low event has occurred)

Reading at this address clears INT1_SRC IA bit (and eventually the interrupt signal on the INT1 pin) and allows the refresh of data in the INT1_SRC register if the latched option was chosen.

7.17 INT1_THS_XH (32h)

Table 47. INT1_THS_XH register

-	THSX14	THSX13	THSX12	THSX11	THSX10	THSX9	THSX8
---	--------	--------	--------	--------	--------	-------	-------

Table 48. INT1_THS_XH description

THSX14 - THSX9	Interrupt threshold. Default value: 0000 0000
----------------	---

7.18 INT1_THS_XL (33h)

Table 49. INT1_THS_XL register

THSX7	THSX6	THSX5	THSX4	THSX3	THSX2	THSX1	THSX0
-------	-------	-------	-------	-------	-------	-------	-------

Table 50. INT1_THS_XL description

THSX7 - THSX0	Interrupt threshold. Default value: 0000 0000
---------------	---

7.19 INT1_THS_YH (34h)

Table 51. INT1_THS_YH register

-	THSY14	THSY13	THSY12	THSY11	THSY10	THSY9	THSY8
---	--------	--------	--------	--------	--------	-------	-------

Table 52. INT1_THS_YH description

THSY14 - THSY9	Interrupt threshold. Default value: 0000 0000
----------------	---

7.20 INT1_THS_YL (35h)

Table 53. INT1_THS_YL register

THSR7	THSY6	THSY5	THSY4	THSY3	THSY2	THSY1	THSY0
-------	-------	-------	-------	-------	-------	-------	-------

Table 54. INT1_THS_YL description

THSY7 - THSY0	Interrupt threshold. Default value: 0000 0000
---------------	---

7.21 INT1_THS_ZH (36h)

Table 55. INT1_THS_ZH register

-	THSZ14	THSZ13	THSZ12	THSZ11	THSZ10	THSZ9	THSZ8
---	--------	--------	--------	--------	--------	-------	-------

Table 56. INT1_THS_ZH description

THSZ14 - THSZ9	Interrupt threshold. Default value: 0000 0000
----------------	---

7.22 INT1_THS_ZL (37h)

Table 57. INT1_THS_ZL register

THSZ7	THSZ6	THSZ5	THSZ4	THSZ3	THSZ2	THSZ1	THSZ0
-------	-------	-------	-------	-------	-------	-------	-------

Table 58. INT1_THS_ZL description

THSZ7 - THSZ0	Interrupt threshold. Default value: 0000 0000
---------------	---

7.23 INT1_DURATION (38h)

Table 59. INT1_DURATION register

WAIT	D6	D5	D4	D3	D2	D1	D0
------	----	----	----	----	----	----	----

Table 60. INT1_DURATION description

WAIT	WAIT enable. Default value: 0 (0: disable; 1: enable)
D6 - D0	Duration value. Default value: 000 0000

The **D6 - D0** bits set the minimum duration of the interrupt event to be recognized. Duration steps and maximum values depend on the ODR chosen.

The **WAIT** bit has the following definitions:

Wait = '0': the interrupt falls immediately if the signal crosses the selected threshold

Wait = '1': if the signal crosses the selected threshold, the interrupt falls only after the duration has counted the number of samples at the selected data rate, written into the duration counter register.

Figure 19. Wait disabled

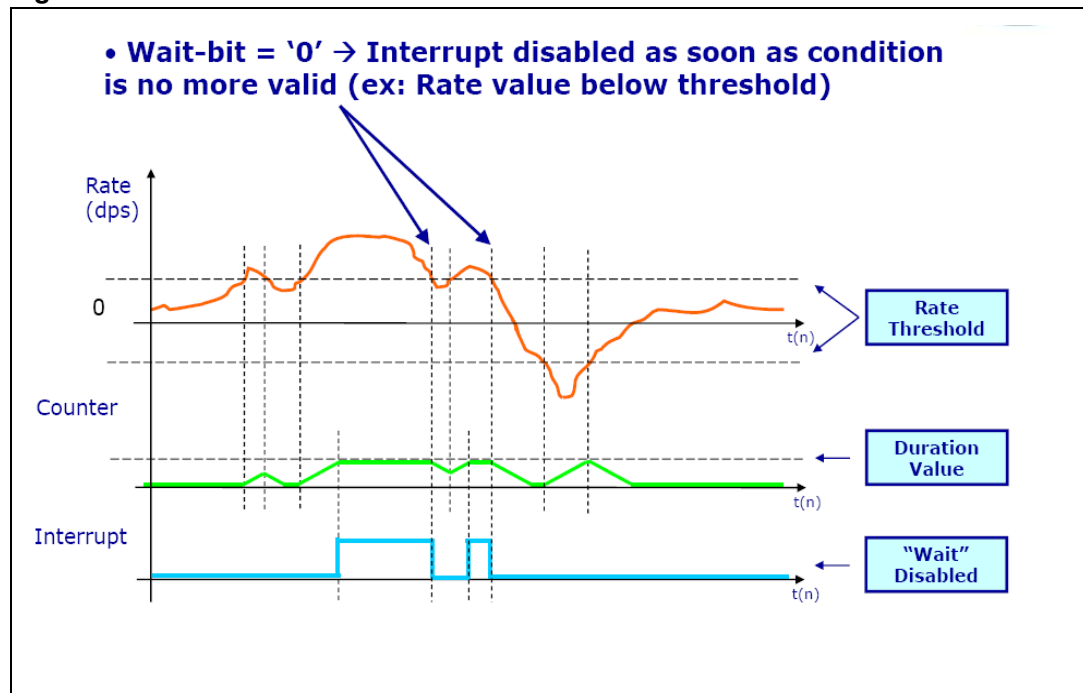
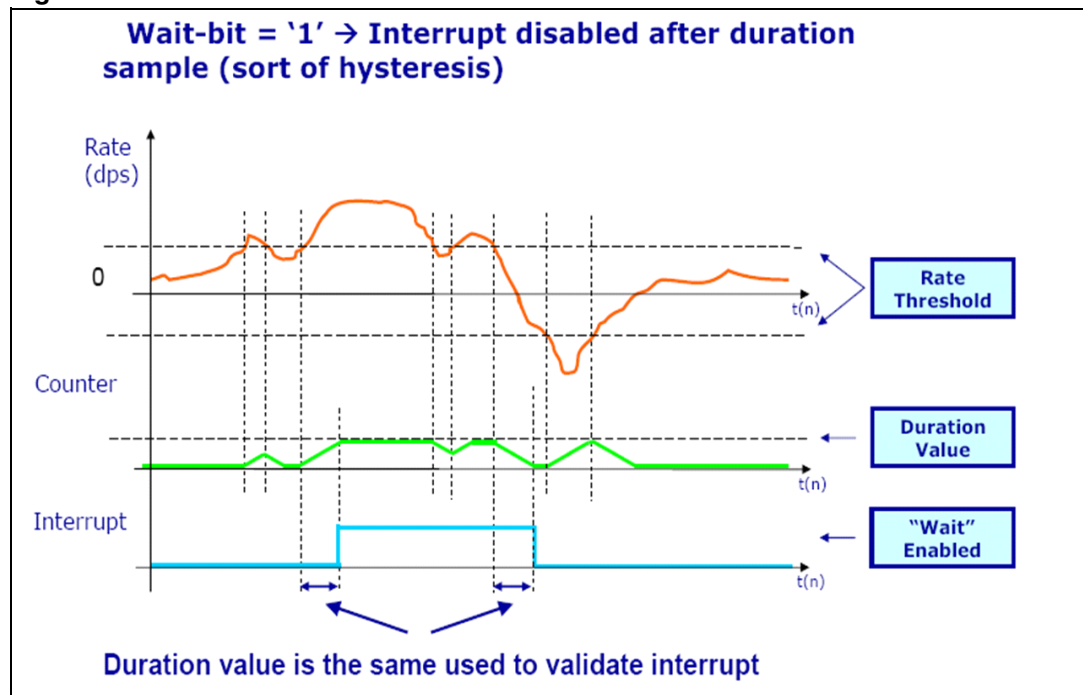


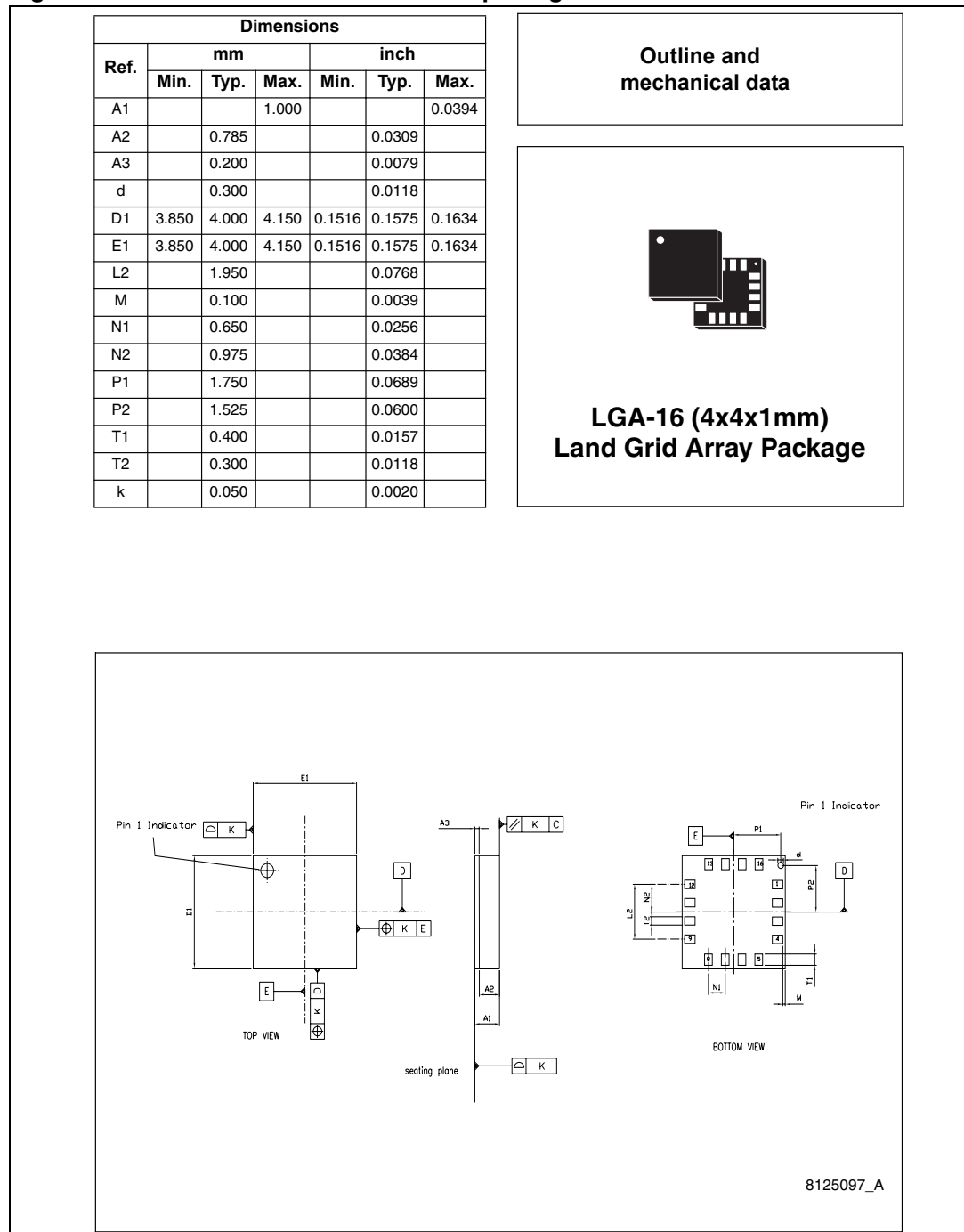
Figure 20. Wait enabled



8 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Figure 21. LGA-16: mechanical data and package dimensions



9 Revision history

Table 61. Document revision history

Date	Revision	Changes
18-Aug-2011	1	Initial release.

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